INTEGRATED CIRCUITS

DATA SHEET

TDA4881Advanced monitor video controller

Preliminary specification File under Integrated Circuits, IC02 November 1992

Philips Semiconductors



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1

TDA4881

FEATURES

- Fully DC controllable
- 3 separate video channels
- · Input black level clamping
- White level adjustment for 2 channels only
- Brightness control with correct grey scale tracking
- Contrast control for all 3 channels simultaneously
- Cathode feedback to internal reference for cut-off control, which allows unstabilized video supply voltage
- Current outputs for RGB signal currents
- RGB voltage outputs to external peaking circuits
- Blanking and switch-off input for screen protection
- Sync on green operation possible

GENERAL DESCRIPTION

The TDA4881 is a monolithic integrated RGB amplifier for colour monitor systems with super VGA performance, intended for DC or AC coupling of the colour signals to the cathodes of the CRT. With special advantages the circuit can be used in conjunction with the TDA4851.

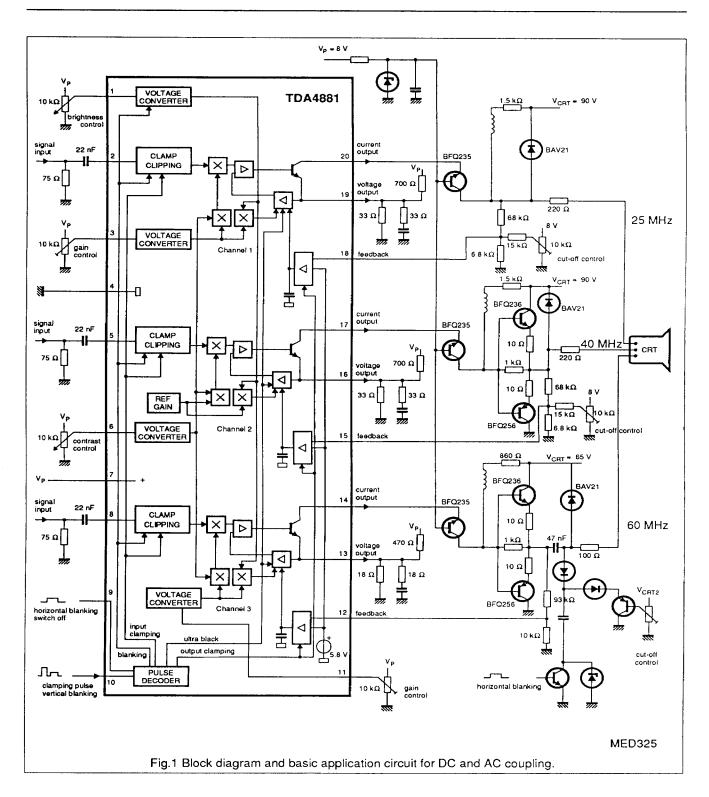
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _P	positive supply voltage (pin 7)		7.2	8.0	8.8	٧
lр	supply current		_	46	56	mA
Vi(b-w)	input voltage (black-to-white, pins 2, 5 and 8)		_	0.7	1.0	V
V _{O(b-w)}	output voltage (black-to-white, pins 19, 16 and 13)	nominal contrast and nominal gain	1	0.8	_	V
lO(b-w)	output current (black-to-white, pins 20, 17 and 14)		_	50	-	mA
IM	peak output current (pins 20, 17 and 14)		-	-	100	mA
В	bandwidth	–3 dB	70	-	_	MHz
Gnom	nominal gain		_	1	-	dB
Gv	gain control range for 2 channels (relative to G _{nom})		-4	_	+2	dB
Cv	contrast control range (relative to G _{nom})		-20	_	+3	dВ
ΔVы	brightness control range	nominal gain	-80	_	+240	mV
T _{amb}	operating ambient temperature range		0	_	+70	°C

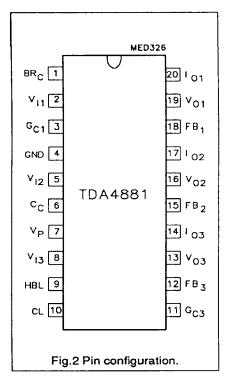
ORDERING INFORMATION

EXTENDED	PACKAGE				
TYPE NUMBER	PINS	PIN POSITION	MATERIAL	CODE	
TDA4881	20	DIL	plastic	SOT146	

TDA4881



TDA4881



FUNCTIONAL DESCRIPTION

RGB input signals (0.7 $V_{(p-p)}$) are capacitively coupled into the TDA4881 (pins 2, 5 and 8) from a low ohmic source and are clamped to an internal DC voltage (artificial black level). Composite signals will not disturb normal operations because an internal clipping circuit cuts all signal parts below black level. Channels 1 and 3 have a maximum total voltage gain of 6 dB (maximum contrast and maximum individual channel gain), Channel 2 of 4 dB (maximum contrast and nominal channel gain). With the nominal channel gain of 1 dB and nominal contrast setting the nominal black-to-white output amplitude is $0.8 V_{(p-p)}$.

DC voltages are used for brightness, contrast and gain control.

Brightness control yields a simultaneous signal black level shift of the three channels relative to a

PINNING

SYMBOL	PIN	DESCRIPTION
BRc	1	brightness control
Vii	2	signal input Channel 1
G _{C1}	3	gain control Channel 1
GND	4	ground
V ₁₂	5	signal input Channel 2
Cc	6	contrast control
VP	7	supply voltage
Vıз	8	signal input Channel 3
HBL	9	horizontal blanking, switch off
CL	10	input clamping, vertical blanking
G _{C3}	11	gain control Channel 3
FB ₃	12	feedback Channel 3
V _{O3}	13	voltage output Channel 3
Іоз	14	current output Channel 3
FB ₂	15	feedback Channel 2
V _{O2}	16	voltage output Channel 2
l _{O2}	17	current output Channel 2
FB ₁	18	feedback Channel 1
V _{O1}	19	voltage output Channel 1
l ₀₁	20	current output Channel 1

reference black level. For nominal brightness (pin 1 open-circuit) the signal black level is equal to the reference black level. Contrast control is achieved by a voltage at pin 6 and affects the three channels simultaneously. To provide the correct white point, an individual gain control (pins 3 and 11) adjusts the signals of Channels 1 and 3 compared to the reference Channel 2. Gain setting effects contrast and brightness to achieve correct grey scale tracking. Each output stage provides a current output (pins 20, 17 and 14) and a voltage output (pins 19, 16 and 13). External cascode transistors reduce power consumption of the IC and prevent breakdown of the output transistors. Signal output currents and peaking characteristics are determined by external components at the voltage outputs and the video supply. The three channels have separate

internal feedback loops which ensure large signal linearity and marginal signal distortion in spite of output transistor thermal V_{BE} variation.

The clamping pulse (pin 10) is used for input clamping only. The input signals have to be at black level during the clamping pulse and are clamped to an internal artificial black level. The coupling capacitors are used in this way for black level storage. Because the threshold for the clamping pulse is higher than that for vertical blanking (pin 10) the rise and fall times of the clamping pulse have to be faster than 75 ns/V (1 V to 3.5 V).

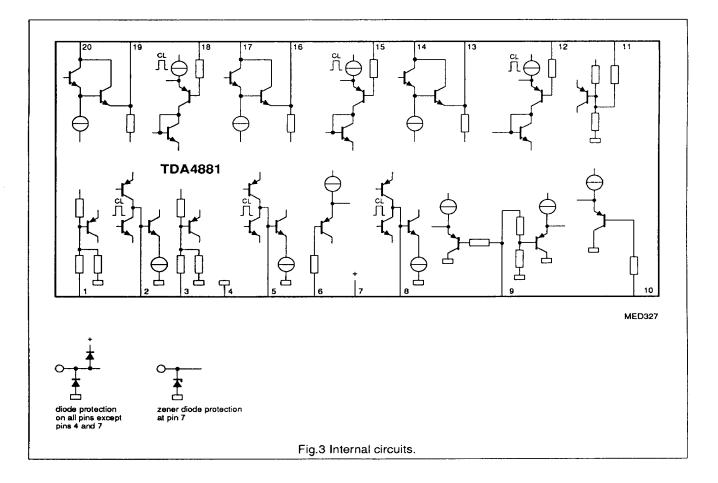
The vertical blanking pulse will be detected if the input voltage (pin 10) is higher than the threshold voltage for approximately 300 ns but does not exceed the threshold for the clamping pulse in the time between. During the vertical blanking pulse the input clamping is disabled to

TDA4881

avoid misclamping in the event of composite input signals. The input signal is blanked and the artificial black level is inserted instead. Additionally the brightness is internally set to its nominal value, thus the output signal is at reference black level. The DC value of the reference black level will be adjusted by cut-off stabilization.

During horizontal blanking (pin 9) the output signal is set to reference black level as previously described and output clamping is activated. If the voltage at pin 9 exceeds the switch off threshold the signal is blanked and switched to ultra black level for screen protection and spot suppression during V-flyback. Ultra black level is the lowest possible output voltage (at voltage outputs) and does not depend on cut-off stabilization.

For cut-off stabilization (DC coupling to the CRT) respectively black level stabilization (AC coupling) the video signal at the cathode or the coupling capacitor is divided by an adjustable voltage divider and fed to the feedback inputs (pins 18, 15 and 12). During horizontal blanking time this signal is compared with an internal DC voltage of approximately 5.8 V. Any difference will lead to a reference black level correction by charging or discharging the integrated capacitor which stores the reference black level information between the horizontal blanking pulses.



TDA4881

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
VР	supply voltage (pin 7)	0	8.8	V
Vi	input voltage range (pins 2, 5 and 8)	-0.1	VP	V
Vext	external DC voltage ranges			
	pins 20, 17 and 14	-0.1	VP	V
	pins 19, 16 and 13	no ex	ternal volt	ages
	pins 1, 3, 6 and 11	-0.1	VP	V
	pin 9	-0.1	Vp + 0.7	V
	pin 10	-0.7	V _P + 0.7	V
lo	average output current (pins 20, 17 and 14)	0	50	mA
lм	peak output current (pins 20, 17 and 14)	0	100	mA
P _{tot}	total power dissipation	_	1200	mW
T _{stg}	storage temperature range	-25	+150	°C
T _{amb}	operating ambient temperature range	0	+70	°C
Tj	junction temperature	-25	+150	°C
VESD	electrostatic handling for all pins (note 1)	-500	+500	V

Note to the Limiting Values

1. Equivalent to discharging a 200 pF capacitor through a 0 Ω series resistor.

THERMAL RESISTANCE

SYMBOL	PARAMETER	THERMAL RESISTANCE
Rth j-a	from junction to ambient in free air	65 K/W

TDA4881

CHARACTERISTICS

Vp = 8.0 V, T_{amb} = +25 °C; all voltages measured to GND (pin 4); unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _P	supply voltage range (pin 7)		7.2	8.0	8.8	V
lp	supply current (pin 7)		_	46	56	mA
Video signa	i inputs					
V _{I(b-w)}	input voltage (black-to-white, pins 2, 5 and 8)		_	0.7	1.0	V
12, 5, 8	DC current	no clamping	-0.1	_	0.1	μА
		during clamping	±50	-	T	μА
Brightness	control			_l		1.'
V ₁	input voltage range	see note 1	1.0	_	6.0	TV
R ₁	input resistance to V _{N1}		_	50	 	kΩ
ΔVы1	black level voltage change at nominal gain (pins 19, 16 and 13)	V ₁ = 1.0 V; V _{3, 11} open-circuit	_	-80	-	mV
		V ₁ = 6.0 V; V _{3, 11} open-circuit	_	240	_	mV
V _{N1}	input voltage for nominal brightness	pin 1 open-circuit	_	2.25	-	V
	ntrol (see note 2)					•
V ₆	input voltage range	see note 1	1.0	T-	6.0	V
l ₆	current		-5	-1	-	μА
Cv	contrast relative to nominal contrast	$V_6 = 6.0 \text{ V};$ $V_{3,11} \text{ open-circuit}$	_	3	-	dB
		$V_6 = 4.5 \text{ V};$ $V_{3, 11}$ open-circuit	-	0	-	dB
		V ₆ = 1.0 V; V _{3, 11} open-circuit	_	-20	_	dB
Tr	tracking of RGB signals	2.5 V < V ₆ < 6 V; V _{3,11} open-circuit	-	0	0.5	dB
Gain contro		· · · · · · · · · · · · · · · · · · ·	1	_ - 		1
V3, 11	input voltage range	see note 1	1.0	T_	6.0	V
R _{3, 11}	input resistance against V _{N3, N11}		 	43	_	kΩ
Gv	gain relative to nominal gain	V ₆ = 4.5 V; V _{3, 11} = 6 V	1_	2	_	dB
		V ₆ = 4.5 V; V _{3, 11} = 1 V	† 	-4	†	dB
VN3, N11	input voltage for nominal gain	pin 3, 11 open-circuit	-	4.6	†	V
Feedback in	put	,	-1	1	·	·
Vint	internal reference voltage	see note 3	tbn	5.8	tbn	V
118, 15, 12	output current	during output clamping	-1.5	-1.0	-0.1	μА
Voltage out	outs (pins 19, 16 and 13)		· · · · · · · · · · · · · · · · · · ·	.1	1	
	signal output voltage (black-to-white value)	$V_{3, 11}$ open; $V_6 = 4.5 \text{ V}$; $V_{I(b-w)} = 0.7 \text{ V}$	-	0.8	_	V
Vы	black level voltage	during output clamping; depending on black level adjustment; see note 4	0.3	_	1.0	V
		during switch-off	-	0.1	0.3	V
S/N	signal-to-noise ratio	see note 5	+	 	44	dB

TDA4881

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Frequency resp	onse at voltage outputs					
Gvi	gain decrease by frequency response at pins 19, 16 and 13	70 MHz	_	-	-3	dB
tro	rise time at voltage output (pins 19, 16 and 13)	10% to 90% amplitude; input rise time = 1 ns	_	4.5	5.0	ns
Current outputs	(pins 20, 17 and 14)					
lo(b-w)	signal current (black-to-white)		<u> </u>	50	_	mA
		with peaking; see note 6	_		100	mA
V ₂₀₋₁₉ , 17-16, 14-13	HF saturation of output transistors	I _O = 50 mA	<u> </u>	_	2.0	V
		lo = 100 mA	_		2.2	V
Threshold volta	ges (see note 7)					
V9	threshold for horizontal blanking (blanking, output clamping)		1.2	1.4	1.6	V
	threshold for switch-off (blanking, minimum black level, no output clamping)		5.8	6.5	6.8	V
R ₉	input resistance referenced to ground		50	80	110	kΩ
tag	delay between horizontal blanking input and output signal blanking		-	35	60	ns
V ₁₀	threshold for vertical blanking (blanking, no input clamping)	see Fig.4	1.2	1.4	1.6	V
	threshold for clamping (input clamping, no blanking)	see Fig.4	2.6	3.0	3.5	V
110	input current		-3	- 1	_	μА
tr,f10	rise and fall time for clamping pulse	transition 1 to 3.5 V; see Fig.4	_		75	ns/V
tw10	clamping pulse width	V ₁₀ = 3 V	0.6	-	-	μs
t _{d10}	delay between vertical blanking input and output signal blanking	see Fig.4	_	300	_	ns

8

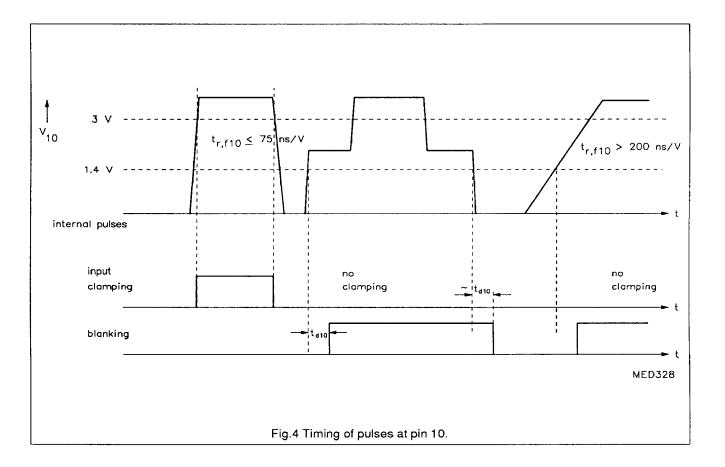
TDA4881

Notes to the characteristics

- 1. Typical range is 1 to 6 V, the range can be increased (e.g. 0 to 7 V) to slightly increase the control range.
- 2. Open contrast control pin leads to undefined contrast setting.
- 3. The internal reference voltage can be measured at pins 18, 15 and 12 during output clamping in closed feedback loop.
- 4. Minimum guaranteed control range, the typical minimum black level voltage is 0.1 V.
- 5. The signal-to-noise ratio is calculated by the formula (frequency range 1 to 70 MHz): peak-to-peak value of the nominal signal output voltage

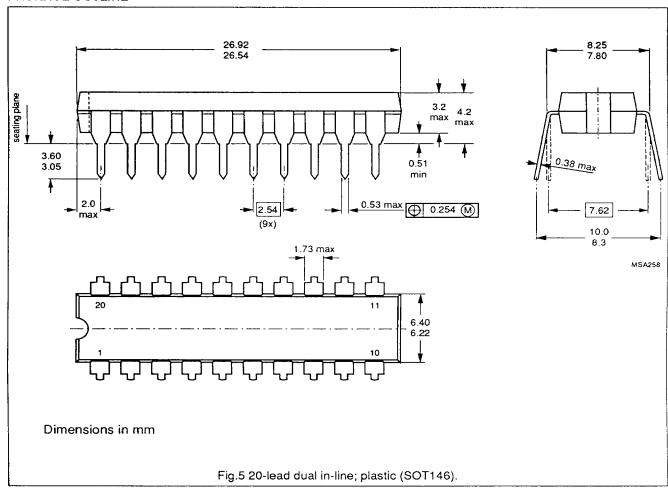
RMS value of the noise output voltage

- 6. The external RC combinations at pins 19, 16 and 13 enables peak currents during transients.
- 7. The internal threshold voltages are derived from an internally stabilized voltage. The internal pulses are generated if the input pulses are higher than the thresholds.



TDA4881

PACKAGE OUTLINE



TDA4881

SOLDERING

Plastic dual in-line packages

BY DIP OR WAVE

The maximum permissible temperature of the solder is 260 °C; this temperature must not be in contact with the joint for more than 5 s. The total contact time of successive solder waves must not exceed 5 s.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified storage maximum. If the printed-circuit board has been preheated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

REPAIRING SOLDERED JOINTS

Apply the soldering iron below the seating plane (or not more than 2 mm above it). If its temperature is below 300 °C it must not be in contact for more than 10 s; if between 300 and 400 °C, for not more than 5 s.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.

Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application Information

Where application information is given, it is advisory and does not form part of the specification.

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12